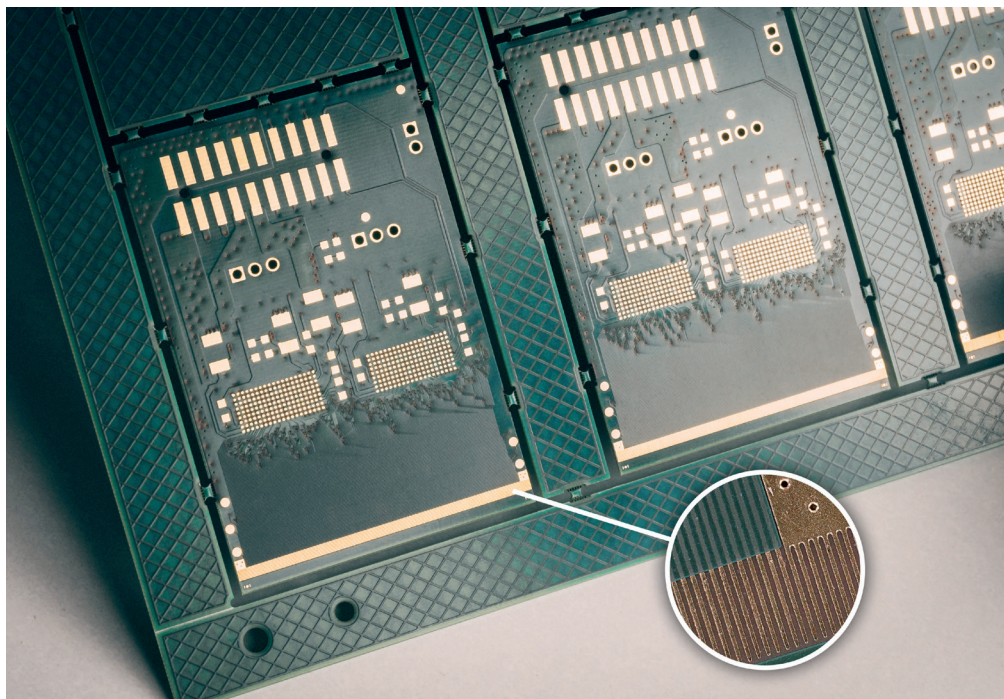


HDI MICROELECTRONICS PCBS



OVERVIEW

HDI PCBs combine miniaturization and high performance. Their production at our Italian facility showcases our know-how and innovation capabilities. With cutting-edge technologies and advanced processes, we meet customer demands with state-of-the-art solutions in microelectronics.

TECHNICAL DATA

TECHNOLOGY:	HDI and Microelectronics PCBs
TYPE:	6 layers
BASE MATERIAL:	FR4 - HTg
THICKNESS:	0,7mm
BASE COPPER OL:	5um
BASE COPPER IL:	18um
MIN. FINISH HOLES:	0,08mm
FINISHING:	ENIG
TRACKS (min):	70um (2.3mil)
ISOLATION (min):	40um (1.5mil)
CHARACTERISTICS:	0.5mm BGA PITCH 0.11mm PITCH CONNECTOR



←
for more info



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